

## **Product Change Notification: SYST-01SSSS214**

Date:

02-May-2025

## **Product Category:**

8-Bit Microcontrollers

## **Notification Subject:**

PIC16(L)F1934/1936/1937 Family Silicon Errata and Data Sheet Clarifications

## **Affected CPNs:**

SYST-01SSSS214\_Affected\_CPN\_05022025.pdf SYST-01SSSS214\_Affected\_CPN\_05022025.csv

## **Notification Text:**

### SYST-01SSSS214

Microchip has released a new Document for the PIC16(L)F1934/1936/1937 Family Silicon Errata and Data Sheet Clarifications of devices. If you are using one of these devices please read the document located at PIC16(L)F1934/1936/1937 Family Silicon Errata and Data Sheet Clarifications.

**Notification Status:** Final

## **Description of Change:**

Updated the document format to the current Microchip publication standard; module numbers under silicon errata have been renumbered accordingly.

Added silicon issue 1.6.3; added data sheet clarification 2.1.

Minor typographic corrections to existing issues.

**Impacts to Data Sheet:** None

Reason for Change: To Improve Productivity.

Change Implementation Status: Complete

**Date Document Changes Effective:** 02 May 2025

**NOTE:** Please be advised that this is a change to the document only the product has not been

changed.

Markings to Distinguish Revised from Unrevised Devices: N/A

## **Attachments:**

PIC16(L)F1934/1936/1937 Family Silicon Errata and Data Sheet Clarifications

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## SYST-01SSSS214 - PIC16(L)F1934/1936/1937 Family Silicon Errata and Data Sheet Clarifications

Affected Catalog Part Numbers (CPN)	
PIC16F1934-E/ML	
PIC16F1934-E/PT	
PIC16F1934-I/P	
PIC16F1934-I/MV	
PIC16F1934-I/ML	
PIC16F1934-I/PT020	
PIC16F1934-I/PT024	
PIC16F1934-I/PT027	
PIC16F1934-I/PT028	
PIC16F1934-I/PT	
PIC16F1934-I/PTV03	
PIC16F1934-I/PTVAO	
PIC16F1934T-I/MV	
PIC16F1934T-I/ML	
PIC16F1934T-I/PT020	
PIC16F1934T-I/PT024	
PIC16F1934T-I/PT027	
PIC16F1934T-I/PT028	
PIC16F1934T-I/PT029	
PIC16F1934T-I/PT	
PIC16F1934T-I/PT024-GM	
PIC16F1934T-I/PT027-GM	
PIC16F1934T-I/PT028-GM	
PIC16F1934T-I/PT029-GM	
PIC16F1934T-I/PTVAO	
PIC16F1934T-E/MLV01	
PIC16LF1934-I/P	
PIC16LF1934-I/ML	
PIC16LF1934-I/PT025	

Date: Thursday, May 1, 2025

SYST-01SSSS214 - PIC16(L)F1934/1936/1937 Family Silicon Errata and Data Sheet Clarifications
PIC16LF1934-I/PT
PIC16LF1934-I/PTVAO
PIC16LF1934T-I/ML
PIC16LF1934T-I/PT
PIC16LF1934T-I/PTVAO
PIC16F1936-E/SP
PIC16F1936-E/ML
PIC16F1936-E/MLVAO
PIC16F1936-E/SS
PIC16F1936-E/SSVAO
PIC16F1936-E/SO
PIC16F1936-E/SOVAO
PIC16F1936-E/MV
PIC16F1936-I/SP036
PIC16F1936-I/SP041
PIC16F1936-I/SP042
PIC16F1936-I/SP
PIC16F1936-I/ML
PIC16F1936-I/MLV03
PIC16F1936-I/MLV03-BW
PIC16F1936-I/SS
PIC16F1936-I/SSC03
PIC16F1936-I/SSV01
PIC16F1936-I/SSV08
PIC16F1936-I/SSVAO
PIC16F1936-I/SO
PIC16F1936-I/SOC04
PIC16F1936-I/MV
PIC16F1936-I/MVVAO
PIC16F1936T-I/ML
PIC16F1936T-I/MLV03
PIC16F1936T-I/MLV03-BW
Date: Thursday, May 1, 2025

SYST-01SSSS214 - PIC16(L)F1934/1936/1937 Family Silicon Errata and Data Sheet Clarifications
PIC16F1936T-I/SS025
PIC16F1936T-I/SS026
PIC16F1936T-I/SS027
PIC16F1936T-I/SS028
PIC16F1936T-I/SS033
PIC16F1936T-I/SS
PIC16F1936T-I/SSC03
PIC16F1936T-I/SSV05
PIC16F1936T-I/SSV09
PIC16F1936T-I/SSV10
PIC16F1936T-I/SSVAO
PIC16F1936T-I/SO022
PIC16F1936T-I/SO023
PIC16F1936T-I/SO031
PIC16F1936T-I/SO032
PIC16F1936T-I/SO040
PIC16F1936T-I/SO043
PIC16F1936T-I/SO
PIC16F1936T-I/SOC04
PIC16F1936T-I/MV
PIC16F1936T-I/MVVAO
PIC16F1936T-E/SS030
PIC16F1936T-E/SSV02
PIC16F1936T-E/SSV03
PIC16F1936T-E/SSV06
PIC16F1936T-E/SSV07
PIC16F1936T-E/SSV11
PIC16F1936T-E/SSVAO
PIC16F1936T-E/SSVAO-GM
PIC16F1936T-E/SO
PIC16F1936T-E/SOVAO
PIC16LF1936-E/SP
Date: Thursday, May 1, 2025

## SYST-01SSSS214 - PIC16(L)F1934/1936/1937 Family Silicon Errata and Data Sheet Clarifications PIC16LF1936-E/ML PIC16LF1936-E/MLVAO PIC16LF1936-E/SS PIC16LF1936-E/SSVAO PIC16LF1936-I/SP PIC16LF1936-I/ML PIC16LF1936-I/SS PIC16LF1936-I/SSVAO PIC16LF1936-I/SO PIC16LF1936-I/MV PIC16LF1936T-I/ML020 PIC16LF1936T-I/ML PIC16LF1936T-I/SS023 PIC16LF1936T-I/SS PIC16LF1936T-I/SSV04 PIC16LF1936T-I/SSVAO PIC16LF1936T-I/SSV04-BW PIC16LF1936T-I/SO PIC16LF1936T-I/MV PIC16LF1936T-E/MLVAO PIC16LF1936T-E/SSV02 PIC16LF1936T-E/SSV02-BW PIC16F1937-E/P PIC16F1937-E/MV PIC16F1937-E/ML PIC16F1937-E/PT PIC16F1937-E/PTVAO PIC16F1937-I/MP PIC16F1937-I/P PIC16F1937-I/MV PIC16F1937-I/ML PIC16F1937-I/PT025 Date: Thursday, May 1, 2025

# PIC16F1937-I/PT PIC16F1937-I/PTC02 PIC16F1937-I/PTVAO PIC16F1937T-I/MP PIC16F1937T-I/MV PIC16F1937T-I/ML PIC16F1937T-I/PT PIC16F1937T-I/PTVAO PIC16F1937T-E/PT PIC16F1937T-E/PTVAO PIC16LF1937/SD02 PIC16LF1937/WMD01 PIC16LF1937-E/P PIC16LF1937-E/ML PIC16LF1937-I/P PIC16LF1937-I/MV PIC16LF1937-I/ML PIC16LF1937-I/PT PIC16LF1937-I/PTVAO PIC16LF1937T-I/MV PIC16LF1937T-I/ML PIC16LF1937T-I/PT PIC16LF1937T-I/PTVAO

SYST-01SSSS214 - PIC16(L)F1934/1936/1937 Family Silicon Errata and Data Sheet Clarifications

Date: Thursday, May 1, 2025

# PIC16(L)F1934/1936/1937 Family Silicon Errata and Data Sheet Clarifications

PIC16(L)F1934/1936/1937



## Introduction

The PIC16(L)F1934/1936/1937 devices that you have received conform functionally to the current device data sheet (DS41364**E**), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in the table below.

The errata described in this document will be addressed in future revisions of the PIC16(L)F1934/1936/1937 silicon.

**Note:** This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current.

Table 1. Silicon Device Identification

				DEVICE ID[1	3:0]					
Part Number	DEV[8:0]	REV[4:0]								
		A2	A3	A5	A6	A7	A8	A9		
PIC16F1934	10 0011 010	0 0010	0 0011	0 0101	0 0110	0 0111	0 1000	0 1001		
PIC16LF1934	10 0100 010	0 0010	0 0011	0 0101	0 0110	0 0111	0 1000	0 1001		
PIC16F1936	10 0011 011	0 0010	0 0011	0 0101	0 0110	0 0111	0 1000	0 1001		
PIC16LF1936	10 0100 011	0 0010	0 0011	0 0101	0 0110	0 0111	0 1000	0 1001		
PIC16F1937	10 0011 100	0 0010	0 0011	0 0101	0 0110	0 0111	0 1000	0 1001		
PIC16LF1937	10 0100 100	0 0010	0 0011	0 0101	0 0110	0 0111	0 1000	0 1001		



**Important:** Refer to the **Device/Revision ID** section in the device data sheet for more detailed information on Device Identification and Revision IDs for your specific device.

## **Silicon Issue Summary**

Table 2. Silicon Issue Summary

Module	Feature	Item	Issue Summary			Affe	cted Revi	sions		
Module	reature	No.	issue Summary	A2	A3	A5	A6	Α7	A8	A9
Data EE Memory	Memory Endurance	1.1.1	Erase/Write Endurance Limited	Х	Х	Χ				
	Writes	1.1.2	Minimum V <sub>DD</sub> for Writes	Χ	Х	Х	X	Χ	X	Х
Program Flash Memory (PFM)	Memory Endurance	1.2.1	Erase/Write Endurance Limited	Χ	X	Χ				
	Writes	1.2.2	Minimum V <sub>DD</sub> for Writes	Χ	X	Χ	Χ	Χ	X	Χ
Capture Compare PWM (CCP)	PWM Dead- Band Delay	1.3.1	Dead-Band Delay Results in Unpredictable Waveforms	Χ	Х	Χ	Х	Х	Х	Χ
	ECCP2 Switching	1.3.2	ECCP2 Switching Between Single, Half-Bridge, and Full-Bridge PWM Modes	Х	X	X	Х	Χ	X	Х
	ECCP2 Changing Direction	1.3.3	ECCP2 PWM Outputs Will Improperly Go Active	Х	X	X	Х	Χ	X	Х
	Capture Mode	1.3.4	Capture Triggered While CCPx Pin is Held High	Χ	X	Χ	X	Х	X	Х
	ECCPx Dead- Band Delay	1.3.5	ECCPx Dead-Band Delay in Half- Bridge Mode	Х	X	Χ	X	Х	X	Х
	PWM with Pulse Steering	1.3.6	Disabling a PWM Output During a PWM Cycle May Stop the Output Earlier than Expected	X	X	Х	X	Χ	X	Х
	Capture Mode	1.3.7	Capture Triggered While CCPx Pin is Held Low	Χ	X	Χ	X	Х	X	Х
Brown-Out Reset (BOR)	Threshold	1.4.1	BOR Threshold Voltage Level	Χ						
Analog-to- Digital Converter (ADC)	ADC Conversion	1.5.1	ADC Conversion May Not Complete	Х	Х	Х				
Oscillator	HS Oscillator	1.6.1	HS Oscillator Minimum V <sub>DD</sub>	Χ	Х	Χ				
(OSC)	Oscillator Start-Up Timer (OSTS) Bit	1.6.2	OSTS Bit Remains Set	Х	Х	Х	Х	X	X	
	MFINTOSC	1.6.3	The Device May not Wake from Sleep when Using the MF Internal Oscillator	Х	Х	Х	Х	Χ	X	Х
Enhanced Capture	Enhanced PWM	1.7.1	PWM 0% Duty Cycle Direction Change	Χ	X	Χ	Χ	Х	X	Χ
Compare PWM (ECCP)	Enhanced PWM	1.7.2	PWM 0% Duty Cycle Port Steering	Χ	X	Χ	Χ	Х	Х	Х
Timer1	Timer0 Gate Source	1.8.1	Gate Toggle Mode Works Improperly	Χ	X	Χ	Χ	Х	Х	Х
	Timer1 Gate Toggle Mode	1.8.2	T1 Gate Flip-Flop Does Not Clear	Х	X	Х	Χ	Х	X	Х
LDO	Minimum V <sub>DD</sub> above 85°C	1.9.1	Minimum Operating V <sub>DD</sub> for the PIC16F193x devices at T <sub>A</sub> > 85°C	Χ	Х	Х	Х	Х	Х	Χ



Table 2. Silicon Issue Summary (continued)

Module	Feature	Item	Issue Summary			Affe	cted Revi	sions		
Wodule	No.		Issue Summary	A2	A3	A5	A6	A7	A8	A9
Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART)	Auto-Baud Detect	1.10.1	Auto-Baud Detect May Store Incorrect Count Value in the SPBRG Registers	X	X	X	X	X		
Resets	RESET Instruction	1.11.1	Extended Reset if Clock is MFINTOSC or HFINTOSC	Х	Х	Χ	Х	Х	X	
Master Synchronous Serial Port (MSSP)	SPI Master Mode	1.12.1	The Buffer Full (BF) Bit or MSSP Interrupt Flag (SSPIF) Bit Becomes Set Half of a SCK Cycle Early	Х	Х	Х	Х	Х	Х	Х

**Note:** Only those issues indicated in the last column apply to the current silicon revision.



## 1. Silicon Errata Issues



This document summarizes all silicon errata issues from all revisions of silicon, previous and current. Only the issues indicated by the bold font in the following tables apply to the current silicon revision.

## 1.1. Module: Data EE Memory

## 1.1.1. Erase/Write Endurance Limited

The typical write/erase endurance of the Data EE Memory is limited to 10k cycles.

#### Work around

Use an error correction method that stores data in multiple locations.

#### **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	А9	
X	Χ	Χ					

## 1.1.2. Minimum V<sub>DD</sub> for Writes

The minimum voltage required for a Data EE write operation is 2.0 volts.

## Work around

None.

## **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	А9	
Χ	X	Χ	Χ	Χ	Χ	X	

## 1.2. Module: Program Flash Memory (PFM)

## 1.2.1. Erase/Write Endurance Limited

The typical write/erase endurance of the PFM is limited to 1k cycles when  $V_{DD}$  is above 3.0 volts. Endurance degrades when  $V_{DD}$  is below 3.0 volts.

### Work around

Use an error correction method that stores data in multiple locations.

## **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	A9	
X	X	X					

## 1.2.2. Minimum V<sub>DD</sub> for Writes

The minimum voltage required for a PFM write operation is 2.0 volts.

#### Work around

None.

## **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	<b>A9</b>	
X	X	X	Χ	Χ	X	Х	



## 1.3. Module: Capture Compare PWM (CCP)

## 1.3.1. Dead-Band Delay Results in Unpredictable Waveforms

When the ECCP is configured for PWM Half-Bridge mode with a dead-band delay greater than or equal to the PWM duty cycle, unpredictable waveforms may result.

#### Work around

Make sure the dead-band delay is always less than the PWM duty cycle.

#### Affected Silicon Revisions

A2	А3	A5	A6	A7	A8	A9	
X	X	X	X	X	X	Х	

## 1.3.2. ECCP2 Switching Between Single, Half-Bridge, and Full-Bridge PWM Modes

Switching PWM modes during the current PWM cycle by modifying the P2M[1:0] bits in the CCP2CON register will cause the PWM outputs to switch immediately and not on the start of the next PWM cycle.

## Work around

None.

#### Affected Silicon Revisions

A2	А3	A5	A6	A7	A8	A9	
X	X	X	X	X	X	Х	

## 1.3.3. ECCP2 PWM Outputs Will Improperly Go Active

When changing directions in Full-Bridge PWM mode, the active and modulated outputs will improperly go active at the same time, and the dead-band delay does not occur, which can lead to large shoot-through currents.

## Work around

None.

## **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	A9	
X	X	X	X	X	X	Х	

## 1.3.4. Capture Triggered While CCPx Pin is Held High

If the module is configured to capture on the first rising edge and the CCPx pin is high at this time, a capture will be triggered.

#### Work around

Clear the CCP Interrupt Flag (CCPxIF = 0) immediately after configuring the module for a capture event.

## **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	A9	
Χ	X	X	X	X	X	X	

## 1.3.5. ECCPx Dead-Band Delay in Half-Bridge Mode

In Half-Bridge mode, the dead-band delay is 1  $T_{OSC}$  longer than calculated for the first PWM cycle and 1.5  $T_{OSC}$  for the following cycles.



#### Work around

None.

## **Affected Silicon Revisions**

A2	А3	A5	A6	A7	A8	A9	
Χ	Χ	Х	Χ	Х	X	х	

## 1.3.6. Disabling a PWM Output During a PWM Cycle May Stop the Output Earlier Than Expected

When the PWM is in Steering mode, disabling a PWM output during a PWM cycle will cause the output to end 1 T<sub>OSC</sub> earlier than expected.

#### Work around

None.

## **Affected Silicon Revisions**

A2	А3	A5	A6	A7	A8	A9	
X	X	X	X	X	X	Х	

## 1.3.7. Capture Triggered While CCPx Pin is Held Low

If the module is configured to capture on the first falling edge and the CCPx pin is low at this time, a capture will be triggered.

## Work around

Clear the CCP Interrupt Flag (CCPxIF = 0) immediately after configuring the module for a capture event.

#### **Affected Silicon Revisions**

A2	А3	A5	A6	A7	A8	A9	
X	X	X	X	X	X	Х	

## 1.4. Module: Brown-Out Reset (BOR)

## 1.4.1. BOR Threshold Voltage Level

When the BOR is configured for 2.5 volt operation, the BOR Reset will typically occur at 2.7 volts.

### Work around

None.

## **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	A9	
X							

## 1.5. Module: Analog-to-Digital Converter (ADC)

## 1.5.1. ADC Conversion May Not Complete

An ADC conversion may not complete under these conditions:

- 1. When  $F_{OSC}$  is greater than 8 MHz and it is the clock source used for the ADC converter.
- The ADC is operating from its dedicated ADCRC oscillator and the device is not in Sleep mode (at any F<sub>OSC</sub> frequency). When this occurs, the ADC Interrupt Flag (ADIF) does not get set, the GO/ DONE bit does not get cleared, and the conversion result does not get loaded into the ADRESH and ADRESL result registers.



## Work around

#### Method 1:

Select the system clock, F<sub>OSC</sub>, as the ADC clock source and reduce the F<sub>OSC</sub> frequency to 8 MHz or less when performing ADC conversions.

#### Method 2:

Select the dedicated ADCRC oscillator as the ADC conversion clock source and perform all conversions with the device in Sleep.

#### Method 3:

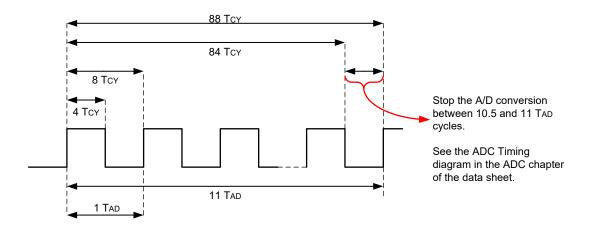
This method is provided if the application cannot use Sleep mode and requires continuous operation at frequencies above 8 MHz. This method requires early termination of an ADC conversion. Provide a fixed time delay in software to stop the ADC conversion manually, after all 10 bits are converted, but before the conversion would complete automatically. The conversion is stopped by clearing the  $GO/\overline{DONE}$  bit in software, and must be cleared during the last ½  $T_{AD}$  cycle, before the conversion would have completed automatically.

In Figure 1-1, 88 instruction cycles will be required to complete the full conversion. Each  $T_{AD}$  cycle consists of 8  $T_{CY}$  periods. A fixed delay is provided to stop the A/D conversion after 86 instruction cycles and terminate the conversion at the correct time.

**Note:** The exact delay time will depend on the  $T_{AD}$  divisor (ADCS) selection. The  $T_{CY}$  counts shown in Figure 1-1 apply to this example only. Refer to Table 1-1 for examples of the required delay counts for other configurations.

Figure 1-1. Instruction Cycle Delay Calculation Example

Fosc = 32 MHz Tcy = 4/32 MHz = 125 ns TaD = 1 µs, ADCS = Fosc/32



See the 'ADC Clock Period (TAD) vs Device Operating Frequency' table in the ADC section of the data sheet.



Table 1-1. Instruction Cycle Delay Counts by T<sub>AD</sub> Selection

T <sub>AD</sub>	Instruction Cycle Delay Counts by T <sub>AD</sub> Selection
F <sub>OSC</sub> /64	172
F <sub>OSC</sub> /32	86
F <sub>osc</sub> /16	43

# Example 1-1. Code Example of Instruction Cycle Delay BSF ADCONO, ADGO ; Start ADC Conversion

; Provide 86 instruction cycle delay here BCF ADCONO, ADGO ; Terminate the conversion manually

MOVF ADRESH, W ; Read the conversion result

#### **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	A9	
X	X	X					

## 1.6. Module: Oscillator (OSC)

## 1.6.1. HS Oscillator Minimum V<sub>DD</sub>

The HS oscillator requires a minimum voltage of 3.0 volts (at 65°C or less) to operate at 20 MHz.

### Work around

None.

### **Affected Silicon Revisions**

A2	А3	A5	A6	A7	A8	A9	
X	X	Х					

#### 1.6.2. OSTS Bit Remains Set

During the Two-Speed Start-up sequence, the Oscillator Start-up Timer (OST) is enabled to count 1024 clock cycles. After the count is reached, the OSTS bit is set, the system clock is held low until the next falling edge of the external crystal (LP, XT, or HS mode), before switching to the external clock source.

When an external oscillator is configured as the primary clock and Fail-Safe Clock mode is enabled (FCMEN = 1), any of the following conditions will result in the OST failing to restart:

- MCLR Reset
- Wake from Sleep
- Clock change from INTOSC to Primary Clock

This anomaly will manifest itself as a clock failure condition for external oscillators which take longer than the clock failure time-out period to start.

#### Work around

None.

#### Affected Silicon Revisions

A2	A3	A5	A6	A7	A8	А9	
X	X	X	X	X	X		



## 1.6.3. The Device May Not Wake From Sleep When Using the MF Internal Oscillator

The device may not wake up from Sleep mode when using the Medium-Frequency Internal Oscillator (MFINTOSC) as the system clock.

#### Work around

To ensure the device wakes up from Sleep, Use one of the following work arounds:

- Use the Low-Frequency Internal Oscillator (LFINTOSC) instead of the MFINTOSC.
- 2. If the MFINTOSC must be used as the system clock:
  - a. Switch to the LFINTOSC before executing the SLEEP command
  - b. Upon wake-up, switch to the 500 kHz MFINTOSC
  - c. Wait for the oscillator start-up time to expire (approximately 2 µs)
  - d. Check the MFIOFR status bit to ensure the MFINTOSC started up
  - e. If the MFIOFR bit is clear, switch to the 500 kHz HFINTOSC
  - f. Wait for the oscillator start-up time to expire (approximately 2 µs)
  - g. When the HFIOFR bit is set, switch back to the 500 kHz MFINTOSC

```
OSCCONbits.IRCF = 0x0;
                               // Select the LFINTOSC
SLEEP();
NOP();
NOP();
OSCCONbits.IRCF = 0x7;
                               // Select the 500 kHz MFINTOSC
                               // Oscillator start-up delay
 _delay_us(2);
if (OSCSTATbits.MFIOFR == 0)
    OSCCONbits.IRCF = 0xA;
                               // Switch to the 500 kHz HFINTOSC
  delay us(2);
                               // Oscillator start-up delay
if (OSCSTATbits.HFIOFR == 1)
    OSCCONbits.IRCF = 0x7;
                               // Switch back to the 500 kHz MFINTOSC
```

## **Affected Silicon Revisions**

A2	А3	A5	A6	A7	A8	A9	
X	X	X	Х	X	Х	X	

## 1.7. Module: Enhanced Capture Compare PWM (ECCP)

## 1.7.1. PWM 0% Duty Cycle Direction Change

When the PWM is configured for Full-Bridge mode and the duty cycle is set to 0%, writing the PxM[1:0] bits to change the direction has no effect on PxA and PxC outputs.

## Work around

Increase the duty cycle to a value greater than 0% before changing directions.

## **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	А9	
X	X	X	X	X	X	X	

## 1.7.2. PWM 0% Duty Cycle Port Steering

In PWM mode, when the duty cycle is set to 0% and the STRxSYNC bit is set, writing the STRxA, STRxB, STRxC, and the STRxD bits to enable/disable steering to port pins has no effect on the outputs.



### Work around

Increase the duty cycle to a value greater than 0% before enabling/disabling steering to port pins.

#### Affected Silicon Revisions

A2	A3	A5	A6	A7	A8	A9	
X	X	X	X	X	X	X	

## 1.8. Module: Timer1

## 1.8.1. Gate Toggle Mode Works Improperly

Timer1 Gate Toggle mode provides unexpected results when Timer0 overflow is selected as the Timer1 Gate source. We do not recommend using Timer0 overflow as the Timer1 Gate source while in Timer1 Gate Toggle mode or when Toggle mode is used in conjunction with Timer1 Gate Single-Pulse mode.

### Work around

None.

### **Affected Silicon Revisions**

A2	А3	A5	A6	A7	A8	A9	
X	X	X	X	X	X	Х	

## 1.8.2. T1 Gate Flip-Flop Does Not Clear

When Timer1 Gate Toggle mode is enabled, clearing the TMR1ON bit does not clear the output value of the flip-flop and hold it clear.

When Timer1 Gate Toggle mode is enabled, it is possible to measure the full-cycle length of a Timer1 gate signal. To perform this function, the Timer1 gate source is routed through a flip-flop that changes state on every incrementing edge of the gate signal. Timer1 Gate Toggle mode is enabled by setting the T1GTM bit of the T1GCON register. When working properly, clearing either the T1GTM bit or the TMR1ON bit would also clear the output value of this flip-flop, and hold it clear. This is done in order to control which edge is being measured.

#### Work around

Clear the T1GTM bit in the T1GCON register to clear, and hold, clear the output value of the flip-flop.

## **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	A9	
Χ	X	X	X	X	X	х	

## 1.9. Module: Low Dropout (LDO) Voltage Regulator

## 1.9.1. Minimum Operating V<sub>DD</sub> for the PIC16F193x Devices at TA > 85°C

The minimum voltage required for the PIC16F193x devices is 3.5 volts for temperatures above 85°C. **Note:** This issue only applies to the PIC16F193x devices operating in the Extended temperature range. The PIC16F193x devices are not affected.

## Work around

None.

## **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	A9	
X	X	X	X	X	X	х	



# 1.10. Module: Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART)

## 1.10.1. Auto-Baud Detect May Store Incorrect Count Value in the SPBRG Registers

When using automatic baud detection (ABDEN), on occasion, an incorrect count value can be stored at the end of the auto-baud detection in the SPBRGH:SPBRGL (SPBRG) registers. The SPBRG value may be off by several counts. This condition happens sporadically when the device clock frequency drifts to a frequency where the SPBRG value oscillates between two different values. The issue is present regardless of the baud rate Configuration bit settings.

#### Work around

When using auto-baud, it is good practice to always verify the obtained value of SPBRG, to ensure it remains within the application specifications. Two recommended methods are shown below.

For additional auto-baud information, see Technical Brief TB3069, "Use of Auto-Baud for Reception of LIN Serial Communications Devices: Mid-Range and Enhanced Mid-Range".

## Example 1-2. Method 1 - EUSART Auto-Baud Detect Work Around

**Note:** In firmware, define default, minimum, and maximum auto-baud (SPBRG) values according to the application requirements. For example, if the application runs at 9600 baud at 16 MHz, then the default SPBRG value would be (assuming 16-bit Asynchronous mode)  $0 \times 67$ . The minimum and maximum allowed values can be calculated based on the application. In this example, a  $\pm 5\%$  tolerance is required, so tolerance is  $0 \times 67 * 5\% = 0 \times 05$ .

#### Example 1-3. Method 2 - EUSART Auto-Baud Detect Work Around

```
#define SPBRG 16BIT *((*int)&SPBRG; // Define location for 16-bit SPBRG value
                                                   // Default Auto-Baud value
const int DEFAULT BAUD = 0x0067;
const int TOL = 0 \times 05;
                                                      // Baud rate % tolerance
const int MIN BAUD = DEFAULT BAUD - TOL; // Minimum Auto-Baud limit
const int MAX BAUD = DEFAULT BAUD + TOL; // Maximum Auto-Baud limit
int Average Baud; // Define Average Baud variable
int Integrator; // Define Integrator variable
Average_Baud = DEFAULT_BAUD; // Set initial average baud rate
Integrator = DEFAULT_BAUD * 15; // The running 16 count average
ABDEN = 1;
                                                   // Start Auto-Baud
while(ABDEN);
                                                    // Wait until Auto-Baud completes
Integrator+ = SPGRB 16BIT;
Average Baud = Integrator/16;
if((SPBRG 16BIT > MAX BAUD) || (SPBRG 16BIT < MIN BAUD))</pre>
                                            // Check if value is within limits
// If out of spec, use previous average
{
     SPBRG_16BIT = Average Baud;
else
                                                  // If in spec, calculate the running
                                                  // average but continue using the
{
     Integrator+ = SPBRG 16BIT;
                                                  // Auto-Baud value in SPBRG
     Average Baud = Integrator/16;
```



```
Integrator- = Average_Baud;
}
```

**Note:** Similar to Method 1, define default, minimum, and maximum auto-baud (SPBRG) values. In firmware, compute a running average of SPBRG. If the new SPBRG value falls outside the minimum or maximum limits, then use the current running average. For example, if the application runs at 9600 baud at 16 MHz, then the default SPBRG value would be (assuming 16-bit Asynchronous mode) 0x67. The minimum and maximum allowed values can be calculated based on the application. In this example, a  $\pm 5\%$  tolerance is required, so tolerance is 0x67 \* 5% = 0x05.

## **Affected Silicon Revisions**

A2	А3	A5	A6	A7	A8	A9	
Χ	X	X	X	X			

## 1.11. Module: Resets

## 1.11.1. Extended Reset if Clock Selection is MFINTOSC or HFINTOSC

When using either the MFINTOSC or HFINTOSC as the primary clock source, and after executing a RESET instruction or when the device executes a Stack Overflow/Underflow Reset, the device may remain in Reset.

## Work around

**Method 1:** Use the Watchdog Timer (WDT) to recover from this issue.

Method 2: In place of the RESET instruction, use GOTO 0x0000.

### **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	A9	
Χ	X	X	X	X	X		

## 1.12. Module: Master Synchronous Serial Port (MSSP)

## 1.12.1. The Buffer Full (BF) Bit or MSSP Interrupt Flag (SSPIF) Bit Becomes Set Half of a SCK Cycle Early

When the MSSP is used in SPI Master mode and the CKE bit is clear (CKE = 0), the Buffer Full (BF) bit and the MSSP Interrupt Flag (SSPIF) bit becomes set half an SCK cycle early. If the user software immediately reacts to either of the bits being set, a write collision may occur as indicated by the WCOL bit being set.

### Work around

To avoid a write collision, one of the following methods should be used:

#### Method 1:

Add a software delay of one SCK period after detecting the completed transfer (the BF bit or SSPIF bit becomes set) and prior to writing to the SSPBUF register. Verify the WCOL bit is clear after writing to SSPBUF. If the WCOL bit is set, clear the bit in software and rewrite the SSPBUF register.

#### Method 2:

As part of the MSSP initialization procedure, set the CKE bit (CKE = 1).

## **Affected Silicon Revisions**

A2	A3	A5	A6	A7	A8	A9	
X	X	X	Χ	X	X	X	



## 2. Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS41364 $\mathbf{E}$ ):

#### Note:

Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

## 2.1. V<sub>OL</sub>/V<sub>OH</sub> Note 4 Correction

In **Section 30.4: "DC Characteristics: PIC16(L)F1934/6/7-I/E"**, Note 4 has been corrected as shown in the table below (in **bold**):

Param No.	Sym.	Characteristic s	Min.	Тур†	Max.	Units	Conditions
D080	V <sub>OL</sub>	Output Low Vo	ltage <sup>(4)</sup>	•			
							$I_{OL} = 8.0 \text{ mA},$ $V_{DD} = 5.0 \text{V}$
	А	All I/O Pins	_	_	0.6	V	$I_{OL} = 6.0 \text{ mA},$ $V_{DD} = 3.3 \text{V}$
							$I_{OL} = 1.8 \text{ mA},$ $V_{DD} = 1.8 \text{ V}$
D090	V <sub>OH</sub>	Output High Vo	oltage <sup>(4)</sup>				
							$I_{OH} = 3.5 \text{ mA},$ $V_{DD} = 5.0 \text{V}$
		All I/O Pins	V <sub>DD</sub> - 0.7	_	_	V	$I_{OH} = 3.0 \text{ mA},$ $V_{DD} = 3.3 \text{V}$
							$I_{OH} = 1.0 \text{ mA},$ $V_{DD} = 1.8$

<sup>\*</sup> These parameters are characterized but not tested.

### Notes:

- 1. In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended to use an external clock in RC mode.
- 2. Negative current is defined as current sourced by the pin.
- 3. The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 4. Including the OSC2 pin with CLKOUT mode disabled.



<sup>†</sup> Data in "Typ." column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

## 3. Appendix A: Revision History

Doc. Rev.	Date	Comments
N		Updated the document format to the current Microchip publication standard; module numbers under silicon errata have been renumbered accordingly.  Added silicon issue 1.6.3; added data sheet clarification 2.1.  Minor typographic corrections to existing issues.
М	11/2014	Added silicon issue 1.12.1; other minor corrections.
L	11/2013	Added silicon revision A9; added silicon issues 1.6.2 and 1.11.1; other minor corrections.
K	07/2012	Added silicon revision A8; removed errata issues 1.6.2, 1.6.3, and 1.6.4.
J	07/2012	Removed DS Clarifications module 1.
Н	02/2012	Added silicon issues 1.6.2, 1.6.3, 1.6.4, and 1.10.1; added DS Clarifications module 1; other minor corrections.
G	09/2011	Added silicon revision A7; Removed DS Clarifications 1 and 2.
F	09/2010	Added silicon issue 1.9.1.
Е	07/2010	Revised item 1.5.1; added issue 1.8.2; other minor corrections.
D	06/2010	Added silicon revision A6.
С	05/2010	Added errata issues 1.5.1, 1.6.1, 1.6.2, 1.7.1, 1.7.2, 1.8.1; added DS Clarifications modules 1 and 2.
В	01/2010	Added silicon revision A5.
Α	09/2009	Initial release of this document.



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PIC16F1934, PIC16F1936, PIC16F1937

